#### EW3B0000713-A 10GBASE, XFP, SR Transceiver



### Features

- Supports 8.0Gb/s to 11.1Gb/s bit rates
- Hot-pluggable XFP footprint, Built-in digital diagnos
- Maximum link length of 300m with MMF-OM3
- 850nm VCSEL laser and PIN photodiode
- XFP MSA package with duplex LC connector
- No reference clock required
- Single +3.3V power supply
- Power dissipation <1.5W
- Compatible with RoHS
- Temperature range: 0 to +70°C



### **Applications**

- SONET OC-192&SDH STM-64 at 9.953Gbps
- 10GBASE-SR/SW 10G Ethernet
- 1200-MX-SN-I 10Gigabit Fiber Channel
- 10GE over G.709 at 11.09Gbps
- OC192 over FEC at 10.709Gbps
- Other optical links, up to 11.3Gbps

#### 1. Description

The XFP module is compliant with the 10G Small Form-Factor Pluggable (XFP) Multi-Source Agreement (MSA), supporting data-rate of 8.0~11.1Gbps, and transmission distance up to 300m with OM3 MMF.

The transceiver module comprises a transmitter with 850nm VCSEL laser and a receiver with a PIN photodiode. Transmitter and receiver are separate within a wide temperature range and offers optimum heat dissipation and excellent electromagnetic shielding thus enabling high port densities for 10 GbE systems.



# 2. Absolute Maximum Ratings

Any stress beyond the maximum ratings can result in permanent damage. The device specifications are guaranteed only under the recommended operating conditions.

Parameter	Symbol	Min	Мах	Unit
Supply Voltage	Vcc	-0.5	4.5	V
Storage Temperature	Ts	-40	+85	°C
Operating Humidity	-	5	85	%

# **3. Recommended Operating Conditions**

Parameter	Symbol	Min	Typical	Мах	Unit
Operating Case Temperature	Tc	0		+70	°C
Power Supply Voltage @3.3V	Vcc	3.135	3.30	3.465	V
Power Supply Current	lcc			500	mA
Data Rate		8.0		11.1	Gbps

# 4. Optical and Electrical Characteristics

Transmitter								
Parai	Symbol	Min	Тур	Max	Unit	Notes		
Centre Wavelength		λς	840	850	860	nm		
Spectral Width (-20d	IB)	Δλ			0.45	nm		
Side-Mode Suppress	sion Ratio	SMSR	-	-	-	dB		
Average Output Pov	ver	Pout	-6.5		-0.5	dBm	1	
Extinction Ratio		ER	3.0			dB		
Data Input Swing Differential		VIN	180		950	mV	2	
Input Differential Impedance		ZIN	90	100	110	Ω		
TV Disable	Disable		2.0		Vcc	V		
TX Disable	Enable		0		0.8	V		
	Receiver							
Parameter		Symbol	Min	Тур	Max	Unit	Notes	
Centre Wavelength		λς	840		860	nm		
Receiver Sensitivity					-11.1	dBm	3	
Receiver Overload			0.5			dBm	3	
LOS De-Assert		LOSD			-12	dBm		
LOS Assert		LOSA	-26			dBm		



Receiver								
Parameter	Symbol	Min	Тур	Max	Unit	Notes		
LOS Hysteresis		0.5		4	dB			
Data Output Swing Differential	Vout	400	600	800	mV	2		
1.05	High	2.0		Vcc	V			
LOS	Low			0.8	V			

### Notes:

- 1. The optical power is launched into SMF.
- 2. Internally AC-coupled.
- 3. Measured with a PRBS  $2^{31}$ -1 test pattern @9953Mbps, BER  $\leq 1 \times 10^{-12}$ .

# 5. Pin Descriptions

Towards ASIC	16   17   18   19   20   21   22   23   24   25   26   27   28   29   30	GND GND RD- MOD_NR RD+ MOD_ABS GND SDA VCC2 SCL P_DOWN/RST VCC3 VCC2 VCC3 GND GND REFCLK+ VCC5 REFCLK+ VCC5 GND INTERRUPT GND INTERRUPT GND MOD_DESEL TD- VEE5 TD+ GND GND GND	15 14 13 12 11 Towards Bezel 10 9 8 7 6 5 4 3 2 1
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Pin	Logic	Symbol	Name/Description	Notes
1		GND	Module Ground	1
2		VEE5	Optional –5.2 Power Supply – Not required	
3	LVTTL-I	Mod-De- sel	Module De-select; When held low allows the module to respond to 2-wire serial interface commands	
4	LVTTL-O	Interrupt	Interrupt (bar); Indicates presence of an important condition which can be read over the serial 2-wire interface	2
5	LVTTL-I	TX_DIS	Transmitter Disable; Transmitter laser source turned off	
6		VCC5	+5 Power Supply – Not required	
7		GND	Module Ground	1
8		VCC3	+3.3V Power Supply	

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Pin	Logic	Symbol	Name/Description	Notes
9		VCC3	+3.3V Power Supply	
10	LVTTL-I	SCL	Serial 2-wire interface clock	2
11	LVTTL- I/O	SDA	Serial 2-wire interface data line	2
12	LVTTL-O	Mod_Abs	Module Absent; Indicates module is not present. Grounded in the module.	2
13	LVTTL-O	Mod_NR	Module Not Ready;	2
14	LVTTL-O	RX_LOS	Receiver Loss of Signal indicator	2
15		GND	Module Ground	1
16		GND	Module Ground	1
17	CML-O	RD-	Receiver inverted data output	
18	CML-O	RD+	Receiver non-inverted data output	
19		GND	Module Ground	1
20		VCC2	+1.8V Power Supply – Not required	
21	LVTTL-I	P_Down/RST	Power Down; When high, places the module in the low power stand-by mode and on the falling edge of P_ Down initiates a module reset. Reset; The falling edge initiates a complete reset of the module including the 2-wire serial interface, equivalent to a power cycle.	
22		VCC2	+1.8V Power Supply – Not required	
23		GND	Module Ground	1
24	PECL-I	RefCLK+	Reference Clock non-inverted input, AC coupled on the host board – Not required	3
25	PECL-I	RefCLK-	Reference Clock inverted input, AC coupled on the host board – Not required	3
26		GND	Module Ground	1
27		GND	Module Ground	1
28	CML-I	TD-	Transmitter inverted data input	
29	CML-I	TD+	Transmitter non-inverted data input	
30		GND	Module Ground	1

#### Notes:

- 1. Module circuit ground is isolated from module chassis ground within the module.
- 2. Open collector, should be pulled up with 4.7k 10k ohms on host board to a voltage between 3.15Vand 3.6V.
- 3. A Reference Clock input is not required.

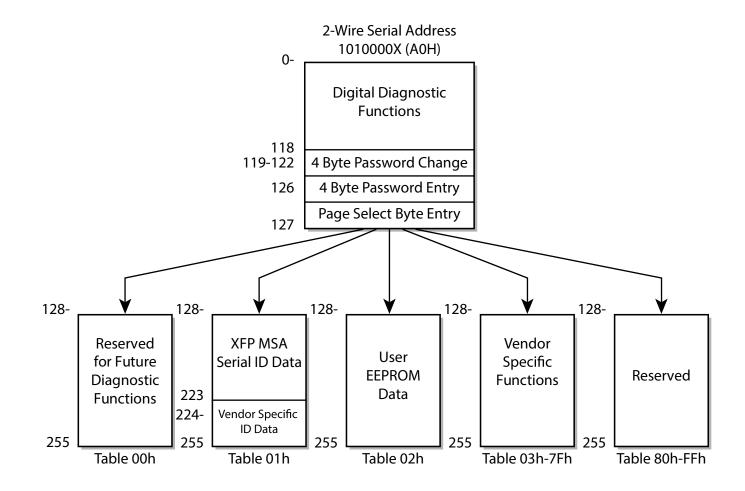


# 6. Management Interface

The transceivers provide serial ID memory contents and diagnostic information about the present operating conditions by the 2-wire serial interface (SCL, SDA).

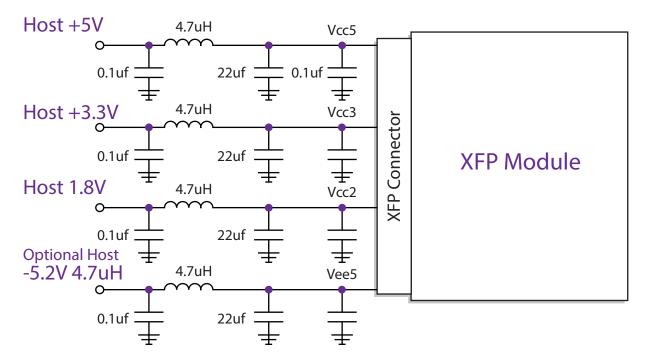
The Module provides diagnostic information about the present operating conditions. The transceiver generates this diagnostic data by digitization of internal analog signals. Alarm/warning threshold data is written during device manufacture. Received power monitoring, transmitted power monitoring, bias current monitoring, supply voltage monitoring and temperature monitoring all are implemented.

The digital diagnostic memory map specific data field defines as following:

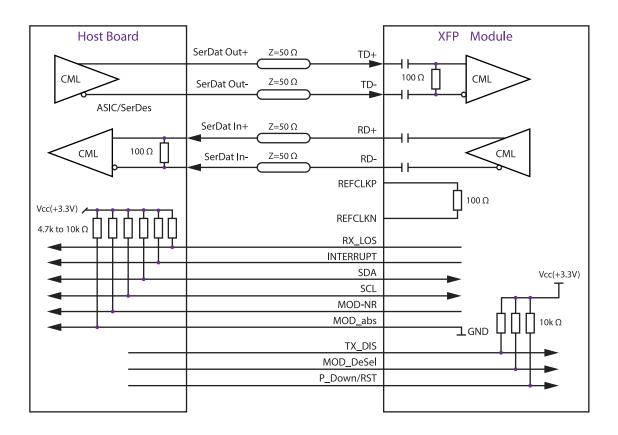




# 7. Recommended Host Board Power Supply Circuit

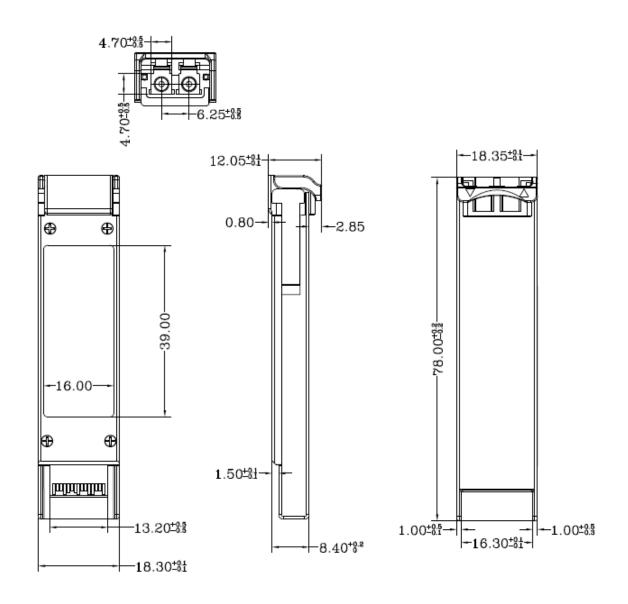


# 8. Recommended High-speed Interface Circuit





# 9. Mechanical Specifications



# **10. Contact Information**

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